



Product Change Notification

Change Notification #: 117418 - 00
Change Title: Intel® Storage Module RMSP3JD160J,
PCN 117418-00, Product Design,
Firmware Update
Date of Publication: February 5, 2020

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	February 18, 2020
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Storage Module RMSP3JD160J:
Update the firmware to PH 10 (firmware package 10.00.01.02)

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change. Customers may need to validate the function and feature change once the post-change system is available.

Please see your Intel representative for further questions or concerns.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre TA#	Pre PBA#	Post TA#	Post PBA#
RMSP3JD160J	954490	J24906-004	J24909-202	J24906-005	J24909-203

PCN Revision History:

Date of Revision: February 5, 2020	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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